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Preferred Device

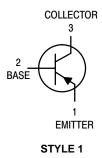
## **General Purpose Transistors**

**PNP Silicon** 



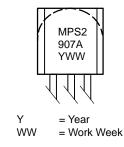
### ON Semiconductor™

#### http://onsemi.com





#### **MARKING DIAGRAMS**



#### **ORDERING INFORMATION**

Device	Package	Shipping
MPS2907A	TO-92	5000 Units/Box
MPS2907ARLRA	TO-92	2000/Tape & Reel
MPS2907ARLRE	TO-92	2000/Ammo Pack
MPS2907ARLRM	TO-92	2000/Ammo Pack
MPS2907ARLRP	TO-92	2000/Ammo Pack

**Preferred** devices are recommended choices for future use and best overall value.

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCEO	-60	Vdc
Collector-Base Voltage	VCBO	-60	Vdc
Emitter-Base Voltage	VEBO	-5.0	Vdc
Collector Current – Continuous	IC	-600	mAdc
Total Device Dissipation  @ T <sub>A</sub> = 25°C  Derate above 25°C	PD	625 5.0	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	1.5 12	Watts mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

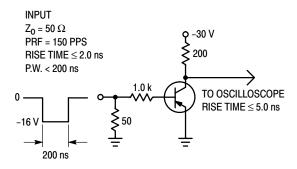
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	200	°C/W
Thermal Resistance, Junction to Case	$R_{ heta JC}$	83.3	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Chara	acteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS		L		1	]
Collector–Emitter Breakdown Voltage (Note 1.) (IC = -10 mAdc, IB = 0)		V(BR)CEO	-60	_	Vdc
Collector–Base Breakdown Voltage (I <sub>C</sub> = –10 μAdc, I <sub>E</sub> = 0)		V(BR)CBO	-60	_	Vdc
Emitter–Base Breakdown Voltage $(I_E = -10 \mu Adc, I_C = 0)$		V(BR)EBO	-5.0	_	Vdc
Collector Cutoff Current (VCE = -30 Vdc, VEB(off) = -0.5 Vdc)		ICEX	_	-50	nAdc
Collector Cutoff Current (V <sub>CB</sub> = -50 Vdc, I <sub>E</sub> = 0) (V <sub>CB</sub> = -50 Vdc, I <sub>E</sub> = 0, T <sub>A</sub> = 150°C)		СВО	- -	-0.01 -10	μAdc
Base Current (VCE = -30 Vdc, VEB(off) = -0.5 Vdc)		I <sub>B</sub>	-	-50	nAdc
ON CHARACTERISTICS					
$ \begin{array}{lll} & DC \ Current \ Gain \\ & (I_{C} = -0.1 \ mAdc, \ V_{CE} = -10 \ Vdc) \\ & (I_{C} = -1.0 \ mAdc, \ V_{CE} = -10 \ Vdc) \\ & (I_{C} = -10 \ mAdc, \ V_{CE} = -10 \ Vdc) \\ & (I_{C} = -150 \ mAdc, \ V_{CE} = -10 \ Vdc) \ (No \ (I_{C} = -500 \ mAdc, \ V_{CE} = -10 \ Vdc) \ (No \ (I_{C} = -500 \ mAdc, \ V_{CE} = -10 \ Vdc) \ (No \ (I_{C} = -10 \ Vdc) \ (I_{C} = -10 \ Vd$		hFE	75 100 100 100 50	- - - 300 -	-
Collector–Emitter Saturation Voltage (No (I <sub>C</sub> = -150 mAdc, I <sub>B</sub> = -15 mAdc) (I <sub>C</sub> = -500 mAdc, I <sub>B</sub> = -50 mAdc)	te 1.)	VCE(sat)	_ _	-0.4 -1.6	Vdc
Base–Emitter Saturation Voltage (Note 1 (I <sub>C</sub> = -150 mAdc, I <sub>B</sub> = -15 mAdc) (I <sub>C</sub> = -500 mAdc, I <sub>B</sub> = -50 mAdc)	.)	VBE(sat)	_ _	-1.3 -2.6	Vdc
SMALL-SIGNAL CHARACTERISTIC	cs				
Current–Gain – Bandwidth Product (Note (I <sub>C</sub> = –50 mAdc, V <sub>CE</sub> = –20 Vdc, f = 10		fT	200	_	MHz
Output Capacitance $(V_{CB} = -10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$		C <sub>obo</sub>	-	8.0	pF
Input Capacitance ( $V_{EB} = -2.0 \text{ Vdc}$ , $I_{C} = 0$ , $f = 1.0 \text{ MHz}$ )		C <sub>ibo</sub>	_	30	pF
SWITCHING CHARACTERISTICS		<del></del>		-	
Turn-On Time	$(V_{CC} = -30 \text{ Vdc}, I_{C} = -150 \text{ mAdc},$	ton	-	45	ns
Delay Time	I <sub>B1</sub> = −15 mAdc) (Figures 1 and 5)	td	-	10	ns
Rise Time		t <sub>r</sub>		40	ns
Turn-Off Time	$(V_{CC} = -6.0 \text{ Vdc}, I_{C} = -150 \text{ mAdc},$	toff	-	100	ns
Storage Time	$I_{B1} = I_{B2} = 15 \text{ mAdc}$ ) (Figure 2)	t <sub>S</sub>	-	80	ns
Fall Time		t <sub>f</sub>	_	30	ns

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 f<sub>T</sub> is defined as the frequency at which |h<sub>fe</sub>| extrapolates to unity.



INPUT  $Z_0 = 50~\Omega$  PRF = 150~PPS  $RISE~TIME \le 2.0~ns$  P.W. < 200~ns 1.0~k 37 TO~OSCILLOSCOPE  $RISE~TIME \le 5.0~ns$  200~ns

Figure 1. Delay and Rise Time Test Circuit

Figure 2. Storage and Fall Time Test Circuit

#### **TYPICAL CHARACTERISTICS**

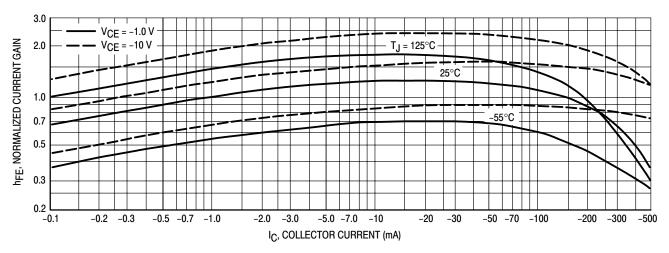


Figure 3. DC Current Gain

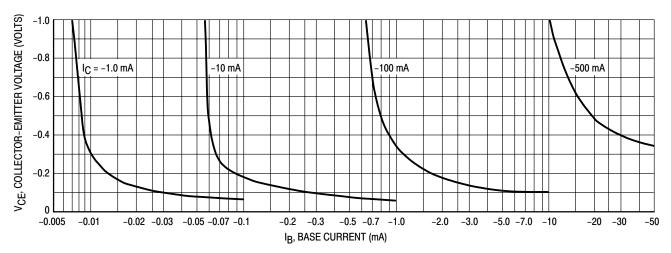
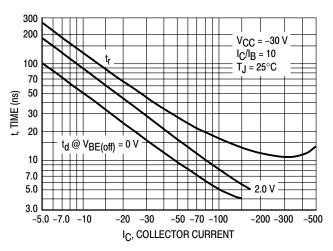


Figure 4. Collector Saturation Region

#### **TYPICAL CHARACTERISTICS**

500

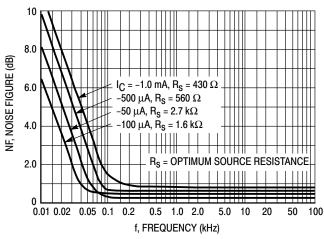


300  $V_{CC} = -30 \text{ V}$  $I_C/I_B = 10$ 200 I<sub>B1</sub> = I<sub>B2</sub> T<sub>J</sub> = 25°C 100 70 50  $t'_{S} = t_{S} - 1/8 t_{f}$ 30 20 10 7.0 -5.0 -7.0 -10 -30 -50 -70 -100 -200 -300 -500 IC, COLLECTOR CURRENT (mA)

Figure 5. Turn-On Time

Figure 6. Turn-Off Time

# TYPICAL SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE $V_{CE} = 10 \; Vdc, \, T_A = 25 ^{\circ}C$





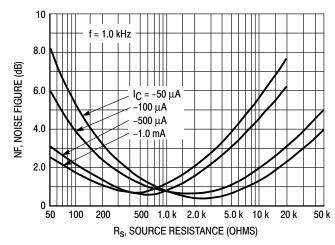
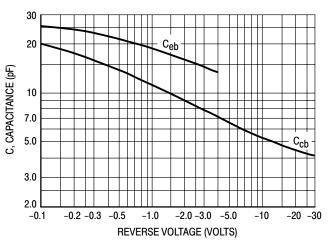


Figure 8. Source Resistance Effects

## TYPICAL SMALL-SIGNAL CHARACTERISTICS **NOISE FIGURE**

 $V_{CE} = 10 \text{ Vdc}, T_A = 25^{\circ}C$ 



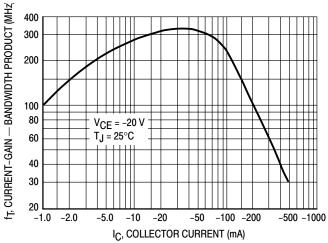


Figure 9. Capacitances

Figure 10. Current-Gain — Bandwidth Product

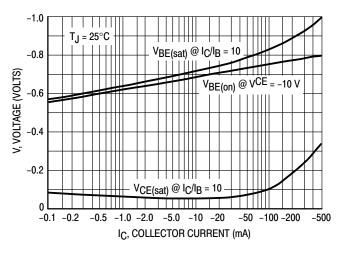


Figure 11. "On" Voltage

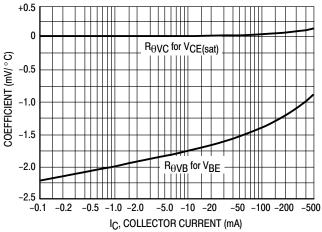
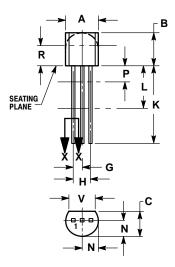


Figure 12. Temperature Coefficients

#### **PACKAGE DIMENSIONS**

#### TO-92 **TO-226AA** CASE 29-11

**ISSUE AL** 





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
  4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
V	0.135		3 //3	

STYLE 1:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

STYLE 14:
PIN 1. EMITTER
2. COLLECTOR
3. BASE

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